

UNISONIC TECHNOLOGIES CO., LTD

UDF004N15

Preliminary

0.04A, 150V N-CHANNEL DEPLETION-MODE POWER MOSFET

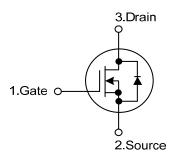
DESCRIPTION

The UTC **UDF004N15** is an N-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed.

FEATURES

- * $R_{DS(ON)} \le 100 \ \Omega$ @ $V_{GS}=0V$, $I_D=20mA$
- * Depletion Mode (Normally On)
- * Proprietary Advanced Planar Technology
- * Rugged Polysilicon Gate Cell Structure
- * Fast Switching Speed

SYMBOL

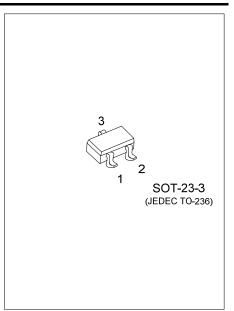


ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UDF004N15L-AE2-R	UDF004N15G-AE2-R	SOT-23-3	G	S	D	Tape Reel	
Note: Pin Assignment: G: Gate S: Source D: Drain							
UDF004N15G-AE2-R	(1) R: Tape Re (2) AE2: SOT- (3) G: Haloger	23-3	d Lead Fro	ee, L: Lea	ad Free		

MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage (Note 2)		V _{DSX}	150	V	
Drain-Gate Voltage (Note 2)		V _{DGX}	150	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Drain Current	Continuous	I _D	0.04	A A	
	Pulsed	I _{DM}	0.08		
Power Dissipation		PD	0.2	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. T_J=+25°C~+150°C.

THERMAL DATA

Junction to Ambient θ_{JA}	625	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSX}	I _D =250μA, V _{GS} =-30V	150			V	
Drain-Source Leakage Current		I _{D(OFF)}	V _{DS} =150V, V _{GS} =-30V			10	μA	
Gate-Source Leakage Current	Forward		V _{GS} =+30V, V _{DS} =0V			+100	nA	
	Reverse	I _{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate to Source Cut Off Voltage		V _{GS(OFF)}	V _{DS} =20V, I _D =8.0µA			-21	V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =25V, V _{GS} =0V	40			mA	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =0V, I _D =20mA			100	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		C _{ISS}			1.4		pF	
Output Capacitance		C _{oss}	V _{GS} =-15V, V _{DS} =25V, f=1.0MHz		3.9		рF	
Reverse Transfer Capacitance		C _{RSS}			2.6		рF	
SWITCHING PARAMETERS								
Turn-ON Delay Time		t _{D(ON)}			75		ns	
Rise Time		t _R	V _{GS} =-15~0V, V _{DD} =30V,		30		ns	
Turn-OFF Delay Time		t _{D(OFF)}	I _D =40mA, R _G =20Ω		35		ns	
Fall-Time		t _F			64		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage		V _{SD}	I _{SD} =40mA, V _{GS} =-10V			1.4	V	

Notes: 1. Repetitive rating, pulse width limited by maximum junction temperature.

2. Pulse width \leq 380µs; duty cycle \leq 2%.



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